

Docket No.: S1459.70088US00
(PATENT)

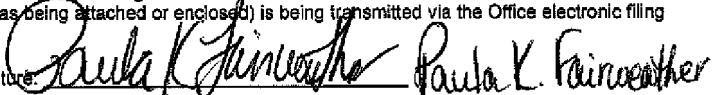
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Masashi Enomoto et al.
Serial No.: 10/822,556
Confirmation No.: 2616
Filed: April 12, 2004
For: PHOTOELECTRIC CONVERSION DEVICE FABRICATION
METHOD, PHOTOELECTRIC CONVERSION DEVICE,
ELECTRONIC APPARATUS MANUFACTURING METHOD,
ELECTRONIC APPARATUS, METAL FILM FORMATION
METHOD AND LAYER STRUCTURE AND SEMICONDUCTOR
FINE PARTICLE LAYER AND LAYER STRUCTURE
Examiner: G. Mowla
Art Unit: 1795

Certificate of Electronic Filing Under 37 CFR 1.8

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted via the Office electronic filing system in accordance with § 1.8(a)(4).

Dated: 5-18-09

Signature: 

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Madam:

INTRODUCTORY COMMENTS

In response to the Office Action dated February 18, 2009, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 23 of this paper.